

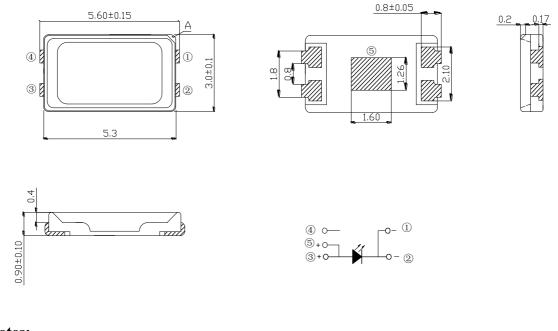
Features

- · 5.6mm*3.0mm SMT LED, Super thin (0.90H mm)
- Wide Viewing Angle
- · Various Colors
- \cdot Compatible with automatic placement equipment.
- \cdot Compatible with infrared and vapor phase reflow and wave solder process.
- · Meet ROHS Green Product

Applications

· Backlight and Indicator

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for indication, not as a basis for the actual structure.

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Form No : Approved By: Rev : VB4 Prepared By: Page: 1 of 5 Date:



Selection Guide

Part No	Lens Type	Dice	Emitted Color	
FSL-5630090W-GBT120N3540ZJ	Yellow	InGaN	White	

Electrical / Optical Characteristics At Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Φv	Luminous Flux	35.0	38.0	40.0	Lm	IF=120mA
201/2	Viewing Angle		110		deg	
Тс	Color Temperature	12000		15000		IF=120mA
Ra	Color Rendering Index	70				IF=120mA
VF	Forward Voltage	3.0	3.4	4.0	V	IF=120mA
IR	Reverse Current			10	uA	VR=5V

Note:

1. $\theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value

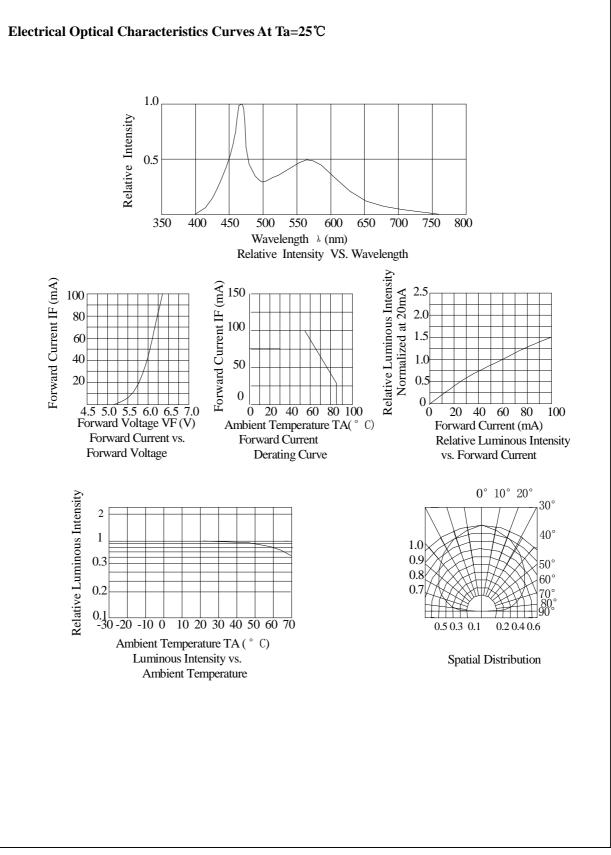
2. The chromaticity coordinates(x,y) is derived form 1931 CIE chromaticity diagram.

3. The chromaticity coordinates(x,y) guarantee should be added ± 0.02 tolerance.

Absolute Maximum Ratings At Ta=25°C

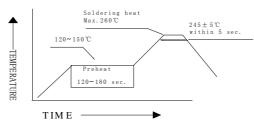
White	Unit	
500	mW	
300	mA	
150	mA	
0.25	mA/°C	
5	V	
2000	V	
-20°C to + 80°C		
-55℃ to + 85℃		
260°C For 5 Seconds		
	500 300 150 0.25 5 2000 -20°C to + 80°C -55°C to + 85°C	







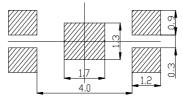
SMT Reflow Soldering Instructions



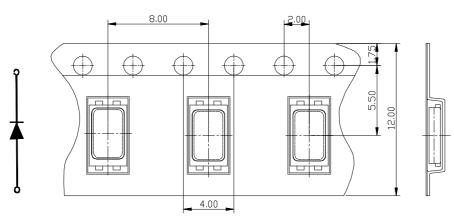
Notes:

- Selles gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- 4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Package Specifications (Units: mm(inches))



Notes:

- 1. The LEDs should be used within a year.
- 2. The LEDs should be kept in $5 \sim 30^{\circ}$ C and 60% RH for less.
- 3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.



Classification	Test Item	Test Conditions	Test hours	Result
Endurance Test	Opertion Life	Connect with a power IF=60mA Ta=Under room temperature	1000Hrs	0/20
	Hige Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
	Hige Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
Environmental Test	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
	Thermal Shock	-35°C∼±5°C∼+85°C∼±5°C 5min 10sec 5min	300 Cycles	0/20
	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating : 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	VF(V)	IF=60mA	Over U×1.2
Reverse current	Ir(µA)	Vr=5V	Over U×2
Luminous intensity	Iv(mcd)	IF=60mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.